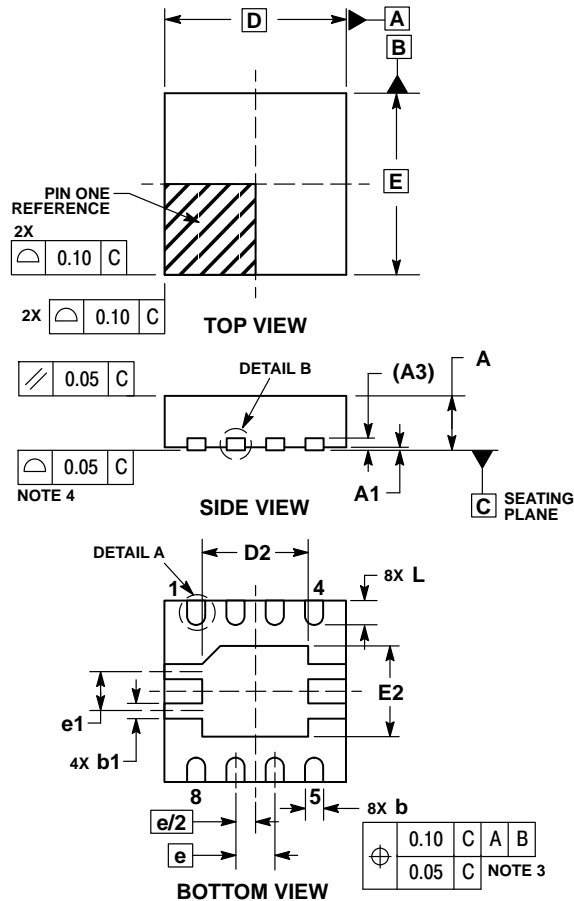




SCALE 2:1

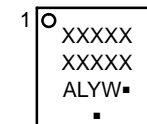
DFN8, 3x3, 0.65P
CASE 506DB
ISSUE A

DATE 12 OCT 2016


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

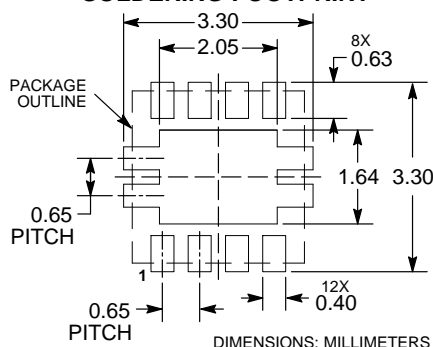
| MILLIMETERS | | |
|-------------|------|------|
| DIM | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 | REF |
| b | 0.25 | 0.35 |
| b1 | 0.20 | 0.30 |
| D | 3.00 | BSC |
| D2 | 1.65 | 1.85 |
| E | 3.00 | BSC |
| E2 | 1.40 | 1.60 |
| e | 0.65 | BSC |
| e1 | 0.65 | REF |
| L | 0.30 | 0.50 |
| L1 | 0.00 | 0.15 |

GENERIC MARKING DIAGRAM*


XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*


*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| | | |
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| DESCRIPTION: | DFN8, 3X3, 0.65P | PAGE 1 OF 1 |

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